

# DATA SHEET

## ANTI-SULFURATED CHIP RESISTORS

AF series  
5%, 1%

sizes 0201/0402/0603/0805/1206/1210/1218/2010/2512

RoHS compliant & Halogen free



SCOPE

This specification describes AF0201 to AF2512 chip resistors with anti-sulfuration capabilities.

APPLICATIONS

- Industrial Equipment
- Power Application
- Networking Application
- High-end Computer & Multimedia Electronics in high sulfur environment

FEATURES

- Superior resistance against sulfur containing atmosphere
- Halogen free product and production
- RoHS compliant
  - Products with lead free terminations meet RoHS requirements
  - Pb-glass contained in electrodes, resistor element and glass are exempted by RoHS
- Reduces environmentally hazardous waste
- High component and equipment reliability
- Saving of PCB space
- Moisture sensitivity level: MSL I

ORDERING INFORMATION - GLOBAL PART NUMBER

Part number is identified by the series name, size, tolerance, packaging type, temperature coefficient, taping reel and resistance value.

**GLOBAL PART NUMBER**

**AF XXXX X X X XX XXXX L**  
 (1) (2) (3) (4) (5) (6) (7)

**(1) SIZE**

0201/0402/0603/0805/1206/1210/1218/2010/2512

**(2) TOLERANCE**

F = ±1%  
J = ±5%

**(3) PACKAGING TYPE**

R = Paper taping reel  
K = Embossed plastic tape reel

**(4) TEMPERATURE COEFFICIENT OF RESISTANCE**

- = Base on spec

**(5) TAPING REEL**

07 = 7 inch dia. Reel	10 = 10 inch dia. Reel
13 = 13 inch dia. Reel	7D = 7 inch Dia. Reel with double quantity

**(6) RESISTANCE VALUE**

1 Ω to 22 MΩ  
 There are 2~4 digits indicated the resistance value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. 1K2, not 1K20.  
 Detailed resistance rules are displayed in the table of "Resistance rule of global part number".

**(7) DEFAULT CODE**

Letter L is system default code for ordering only <sup>(Note)</sup>

Resistance coding rule	Example
XRXX (1 to 9.76 Ω)	1R = 1 Ω 1R5 = 1.5 Ω 9R76 = 9.76 Ω
XXRX (10 to 97.6 Ω)	10R = 10 Ω 97R6 = 97.6 Ω
XXXXR (100 to 976 Ω)	100R = 100 Ω
XKXX (1 to 9.76 KΩ)	1K = 1,000 Ω 9K76 = 9760 Ω
XMXX (1 to 9.76 MΩ)	1M = 1,000,000 Ω 9M76 = 9,760,000 Ω

**ORDERING EXAMPLE**

The ordering code for an AF0402 chip resistor, value 100 KΩ with ±1% tolerance, supplied in 7-inch tape reel with 10Kpcs quantity is: AF0402FR-07100KL.

**NOTE**

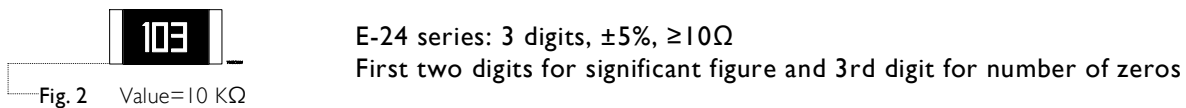
1. All our R-Chip products are RoHS compliant and Halogen free. "LFP" of the internal 2D reel label states "Lead-Free Process"
2. On customized label, "LFP" or specific symbol can be printed

**MARKING**

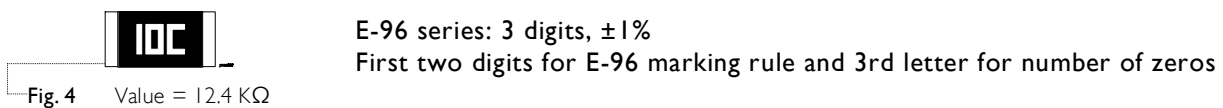
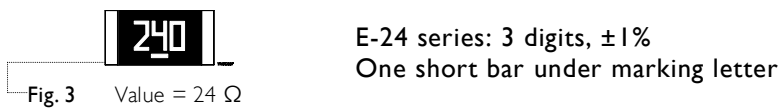
AF0201 / AF0402



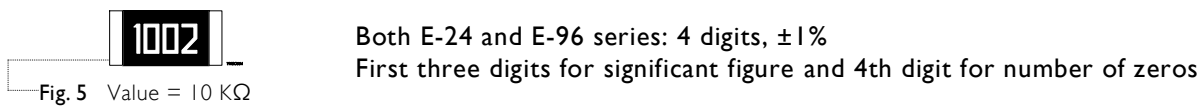
AF0603 / AF0805 / AF1206 / AF1210 / AF2010 / AF2512



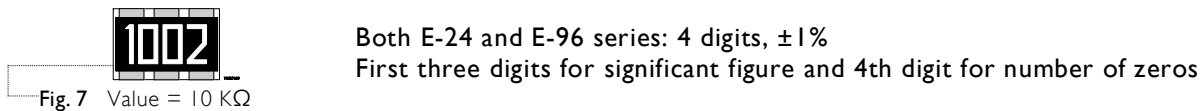
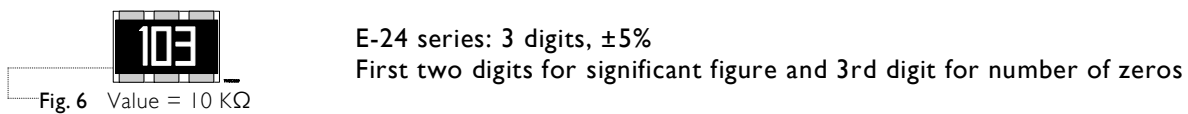
AF0603



AF0805 / AF1206 / AF1210 / AF2010 / AF2512



AF1218



**NOTE**

For further marking information, please see special data sheet "Chip resistors marking". Marking of AF series is the same as RC series

**CONSTRUCTION**

The resistors are constructed on top of a high grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive glaze. The resistive glaze is covered by a lead-free glass. The composition of the glaze is adjusted to give the approximate required resistance value and laser trimming of this resistive glaze achieves the value within tolerance. The whole element is covered by a protective overcoat. Size 0603 and bigger is marked with the resistance value on top. Finally, the two external terminations (Ni / matte tin) are added. See fig.8

**DIMENSIONS**

Table I For outlines see fig. 8

TYPE	L (mm)	W (mm)	H (mm)	l <sub>1</sub> (mm)	l <sub>2</sub> (mm)
AF0201	0.60±0.03	0.30±0.03	0.23±0.03	0.10±0.05	0.15±0.05
AF0402	1.00 ±0.05	0.50 ±0.05	0.32 ±0.05	0.20 ±0.10	0.25 ±0.10
AF0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.25 ±0.15	0.25 ±0.15
AF0805	2.00 ±0.10	1.25 ±0.10	0.50 ±0.10	0.35 ±0.20	0.35 ±0.20
AF1206	3.10 ±0.10	1.60 ±0.10	0.55 ±0.10	0.45 ±0.20	0.40 ±0.20
AF1210	3.10±0.10	2.60±0.15	0.50±0.10	0.45±0.15	0.50±0.20
AF1218	3.10±0.10	4.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
AF2010	5.00±0.10	2.50±0.15	0.55±0.10	0.55±0.15	0.50±0.20
AF2512	6.35±0.10	3.10±0.15	0.55±0.10	0.60±0.20	0.50±0.20

**OUTLINES**

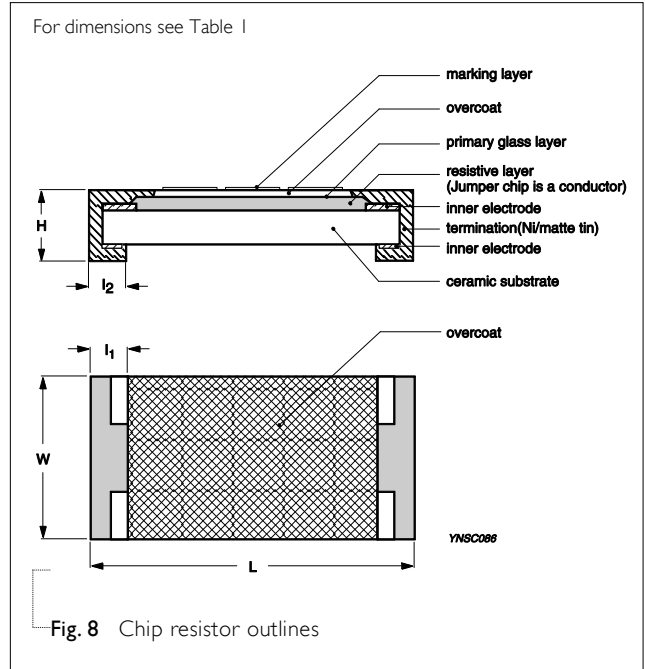


Fig. 8 Chip resistor outlines

**ELECTRICAL CHARACTERISTICS**

Table 2

TYPE	RESISTANCE RANGE	CHARACTERISTICS				Temperature Coefficient of Resistance
		Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	
AF0201	±5% (E24), 1Ω to 10MΩ	-55°C to +125°C	25 V	50 V	50 V	1Ω ≤ R ≤ 10Ω, -100/+350 ppm/°C 10Ω < R ≤ 10MΩ, ±200 ppm/°C
	±1% (E24/E96), 1Ω to 10MΩ Zero Ohm Jumper < 0.05Ω					
AF0402			50 V	100 V	100 V	
AF0603	±5% (E24), 1 Ω to 22 MΩ		75 V	150 V	100 V	1 Ω ≤ R ≤ 10 Ω, ±200 ppm/°C
AF0805	±1% (E24/E96), 1 Ω to 10 MΩ		150 V	300 V	300 V	10 Ω < R ≤ 10 MΩ, ±100 ppm/°C
	Zero Ohm Jumper < 0.05 Ω					10 MΩ < R ≤ 22 MΩ, ±200 ppm/°C
AF1206			200 V	400 V	500 V	
AF1210		-55 °C to +155 °C	200 V	500 V	500 V	
AF1218	±5% (E24), 1Ω to 10MΩ		200 V	500 V	500 V	1Ω ≤ R ≤ 10Ω, ±200 ppm/°C
AF2010	±1% (E24/E96), 1Ω to 10M		200 V	500 V	500 V	10Ω < R ≤ 10MΩ, ±200 ppm/°C
	Zero Ohm Jumper < 0.05Ω					
AF2512			200V	500V	500V	

**FOOTPRINT AND SOLDERING PROFILES**

For recommended footprint and soldering profiles of AF-series is the same as RC-series. Please see the special data sheet “Chip resistors mounting”.

**PACKING STYLE AND PACKAGING QUANTITY**

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	AF0201	AF0402	AF0603/0805/1206	AF1210	AF1218/2010/2512
Paper taping reel (R)	7" (178 mm)	10,000/20,000	10,000/20,000	5,000	5,000	--
	10" (254 mm)	--	20,000	10,000	--	--
	13" (330 mm)	50,000	50,000	20,000	20,000	--
Embossed taping reel (K)	7" (178 mm)	--	--	--	--	4,000

**NOTE**

I. For paper/embossed tape and reel specification/dimensions, please see the special data sheet “Chip resistors packing”.

**FUNCTIONAL DESCRIPTION**

**OPERATING TEMPERATURE RANGE**

AF0201 Range: -55 °C to + 125 °C  
 AF0402 - AF2512 Range: -55 °C to + 155 °C

**POWER RATING**

Each type rated power at 70 °C:

- AF0201=1/20W (0.05W)
- AF0402=1/16 W (0.0625W)
- AF0603=1/10 W (0.1W)
- AF0805=1/8 W (0.125W)
- AF1206=1/4 W (0.25W)
- AF1210=1/2W (0.5W)
- AF1218=1W
- AF2010=3/4W (0.75W)
- AF2512=1W

**RATED VOLTAGE**

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

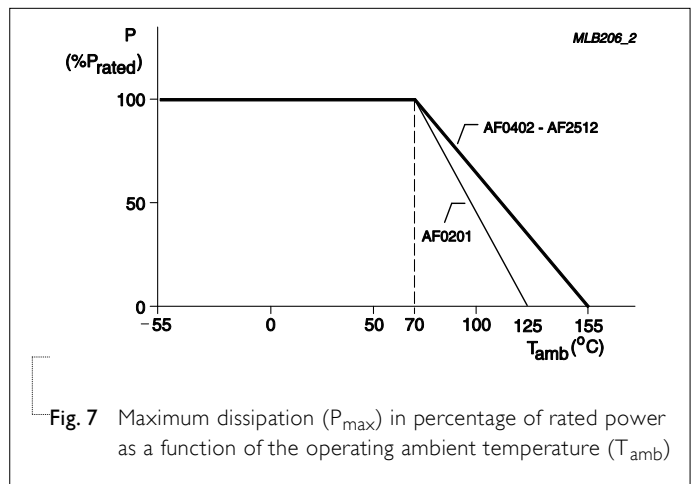
$$V = \sqrt{(P \times R)}$$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

R = Resistance value (Ω)



**TESTS AND REQUIREMENTS**
**Table 4** Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of Resistance (T.C.R.)	IEC 60115-1 4.8	At +25/-55 °C and +25/+125 °C  <b>Formula:</b> $T.C.R = \frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$  Where t <sub>1</sub> = +25 °C or specified room temperature t <sub>2</sub> = -55 °C or +125 °C test temperature R <sub>1</sub> = resistance at reference temperature in ohms R <sub>2</sub> = resistance at test temperature in ohms	Refer to table 2
Life/Endurance	IEC 60115-1 4.25 MIL-STD-202 Method 108	At 70±2 °C for 1,000 hours, RCWV applied for 1.5 hours on, 0.5 hour off, still air required	±(1.0%+0.05 Ω) <100 mΩ for Jumper
High Temperature Exposure/Endurance at Upper Category Temperature	MIL-STD-202 Method 108	1,000 hours at 155±5 °C, unpowered	±(1.0%+0.05 Ω) for 1% tol. ±(1.0%+0.05 Ω) for 5% tol. <100 mΩ for Jumper
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered  Parts mounted on test-boards, without condensation on parts	±(0.5%+0.05 Ω) for 1% tol. ±(1.0%+0.05 Ω) for 5% tol. <100 mΩ for Jumper
Thermal Shock	MIL-STD-202 Method 107	-55 / +125 °C  Number of cycles required is 300. Devices unmounted  Maximum transfer time is 20 seconds. Dwell time is 15 minutes	±(0.5%+0.05 Ω) for 1% tol. ±(1%+0.05 Ω) for 5% tol. <100 mΩ for Jumper
Short Time Overload	IEC60115-1 4.13	2.5 times of rated voltage or maximum overload voltage whichever is less for 5 seconds at room temperature	±(1.0%+0.05 Ω) No visible damage
Bending	IEC 60115-1 4.33 IEC 60068-2-21	Chips mounted on a 90 mm glass epoxy resin PCB (FR4)  Bending: 0201/0402: 5 mm 0603/0805: 3 mm 1206 & above: 2 mm  Bending time: 60±5 seconds	±(1.0%+0.05 Ω) <100 mΩ for Jumper No visible damage

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Biased Humidity (steady state)	IEC 60115-1 4.37	Steady state for 1,000 hours at 40°C / 95% R.H. RCWV applied for 1.5 hours on and 0.5 hour off	±(3.0%+0.05 Ω)
<b>Solderability</b>			
- Resistance to Soldering Heat	IEC 60115-1 4.18 MIL-STD-202 Method 215	Condition B, no pre-heat of samples Lead-free solder, 260±5 °C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(0.5%+0.05 Ω) for 1% tol. ±(1.0%+0.05 Ω) for 5% tol. <50 mΩ for Jumper No visible damage
- Wetting	J-STD-002	Electrical test not required Magnification 10X SMD conditions: (a) Method B, aging 4 hours at 155 °C dry heat, lead-free solder bath at 245 °C (b) Method B, dipping at 215 °C for 3 seconds	Well tinned (≥95% covered) No visible damage
FOS	ASTM-B-809-95	Sulfur (saturated vapor) 1,000 hours, 60±2 °C, 91-93% R.H., unpowered	±(1.0%+0.05 Ω)

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 1	Sep. 27, 2013	-	- Size 0201/1210/1218/2010/2512 extend
Version 0	Jan 07, 2011	-	- First issue of this specification

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